

FS100UMJ-03

HIGH-SPEED SWITCHING USE

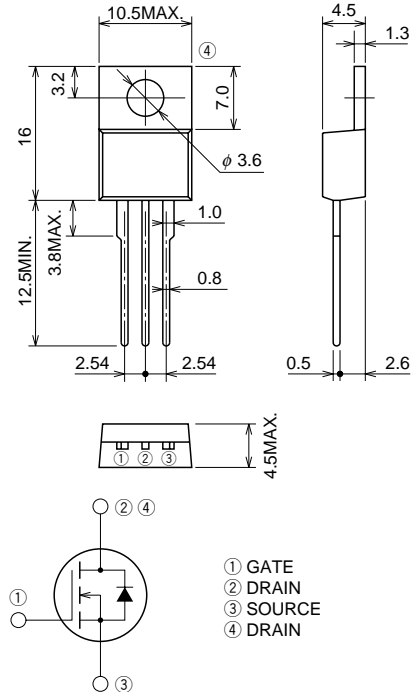
FS100UMJ-03



- 4V DRIVE
- V_{DSS} 30V
- r_{DS (ON)} (MAX) 4.7mΩ
- I_D 100A
- Integrated Fast Recovery Diode (TYP.) 100ns

OUTLINE DRAWING

Dimensions in mm



TO-220

APPLICATION

Motor control, Lamp control, Solenoid control
DC-DC converter, etc.

MAXIMUM RATINGS (T_c = 25°C)

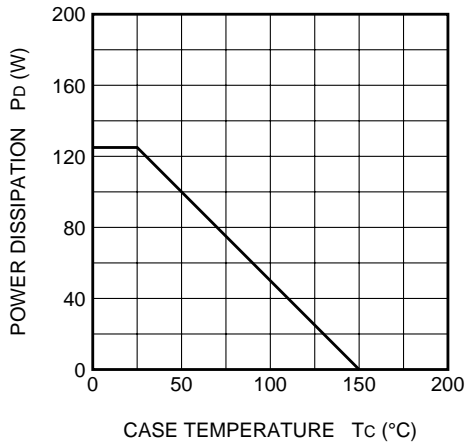
Symbol	Parameter	Conditions	Ratings	Unit
V _{DSS}	Drain-source voltage	V _{GS} = 0V	30	V
V _{GSS}	Gate-source voltage	V _{DS} = 0V	±20	V
I _D	Drain current		100	A
I _{DM}	Drain current (Pulsed)		400	A
I _{DA}	Avalanche drain current (Pulsed)	L = 30μH	100	A
I _S	Source current		100	A
I _{SM}	Source current (Pulsed)		400	A
P _D	Maximum power dissipation		125	W
T _{ch}	Channel temperature		-55 ~ +150	°C
T _{stg}	Storage temperature		-55 ~ +150	°C
—	Weight	Typical value	2.0	g

ELECTRICAL CHARACTERISTICS (Tch = 25°C)

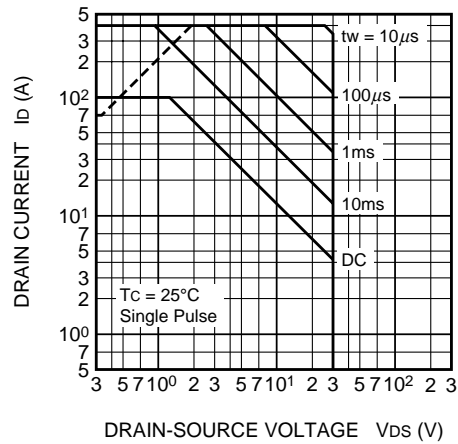
Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V(BR)DSS	Drain-source breakdown voltage	Id = 1mA, Vgs = 0V	30	—	—	V
IgSS	Gate-source leakage current	Vgs = ±20V, Vds = 0V	—	—	±0.1	μA
IbSS	Drain-source leakage current	Vds = 30V, Vgs = 0V	—	—	0.1	mA
VGS(th)	Gate-source threshold voltage	Id = 1mA, Vds = 10V	1.0	1.5	2.0	V
rDS(ON)	Drain-source on-state resistance	Id = 50A, Vgs = 10V	—	3.5	4.7	mΩ
rDS(ON)	Drain-source on-state resistance	Id = 50A, Vgs = 4V	—	4.7	8.0	mΩ
VDS(ON)	Drain-source on-state voltage	Id = 50A, Vgs = 10V	—	0.175	0.235	V
yfs	Forward transfer admittance	Id = 50A, Vds = 10V	—	80	—	S
Ciss	Input capacitance	Vds = 10V, Vgs = 0V, f = 1MHz	—	8000	—	pF
Coss	Output capacitance		—	2250	—	pF
Crss	Reverse transfer capacitance		—	1300	—	pF
td(on)	Turn-on delay time	VDD = 15V, Id = 50A, Vgs = 10V, RGEN = RGS = 50Ω	—	55	—	ns
tr	Rise time		—	190	—	ns
td(off)	Turn-off delay time		—	800	—	ns
tf	Fall time		—	470	—	ns
VSD	Source-drain voltage	Is = 50A, Vgs = 0V	—	1.0	1.5	V
Rth(ch-c)	Thermal resistance	Channel to case	—	—	1.00	°C/W
trr	Reverse recovery time	Is = 50A, dis/dt = -50A/μs	—	100	—	ns

PERFORMANCE CURVES

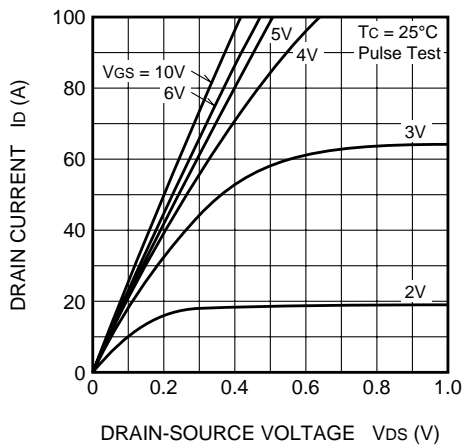
POWER DISSIPATION DERATING CURVE



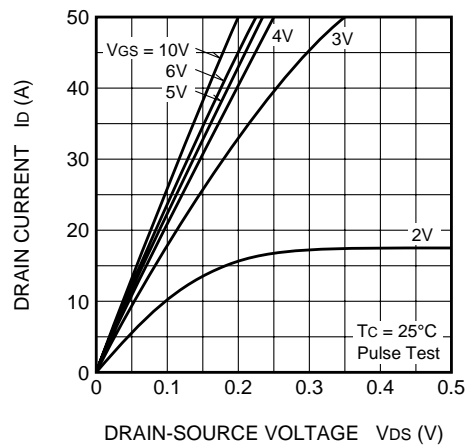
MAXIMUM SAFE OPERATING AREA



OUTPUT CHARACTERISTICS (TYPICAL)



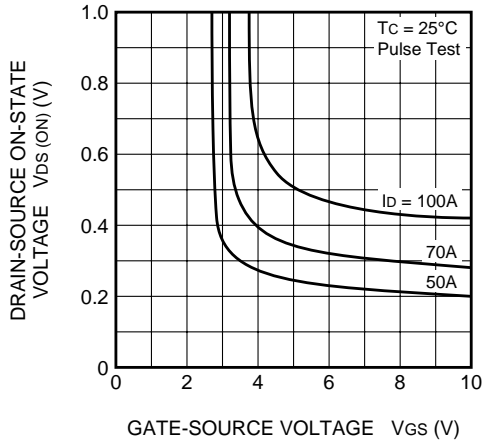
OUTPUT CHARACTERISTICS (TYPICAL)



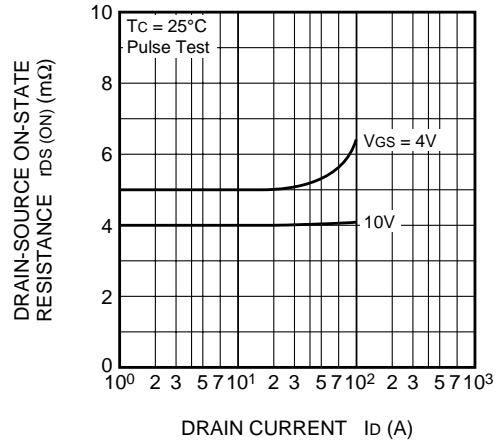
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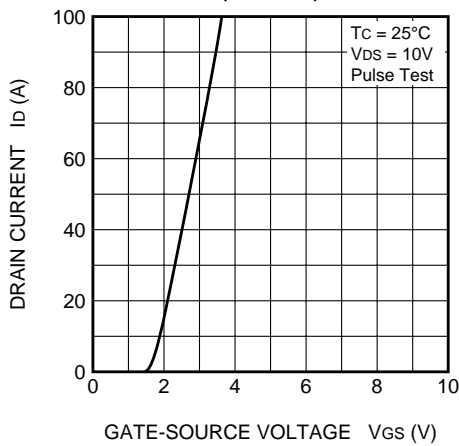
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



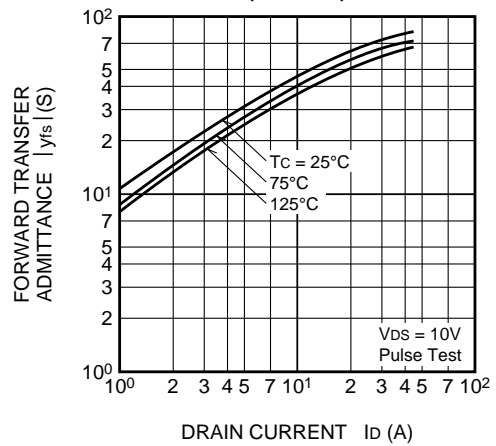
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



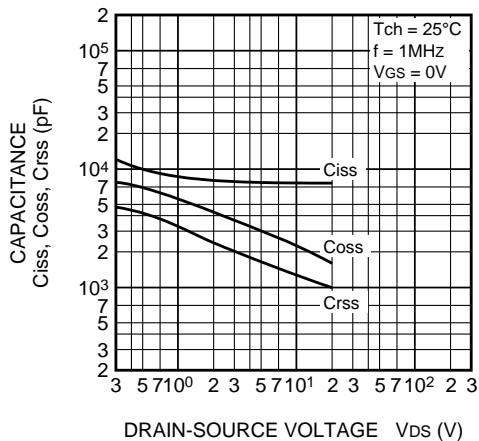
TRANSFER CHARACTERISTICS (TYPICAL)



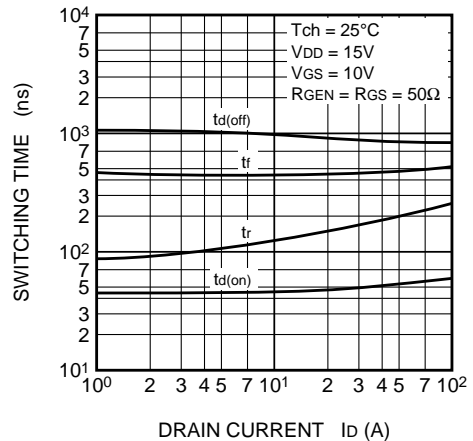
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



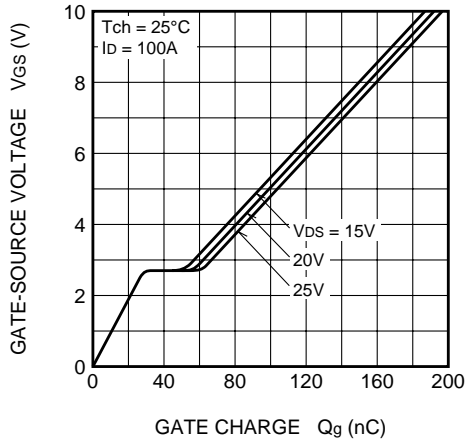
CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



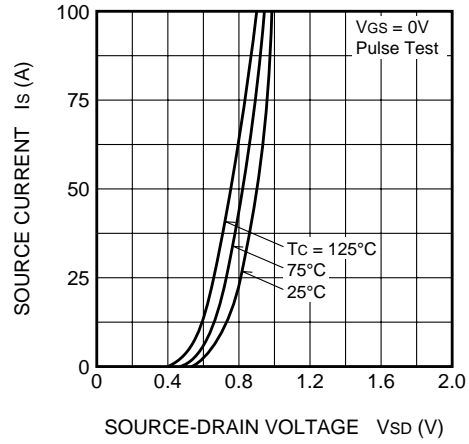
SWITCHING CHARACTERISTICS (TYPICAL)



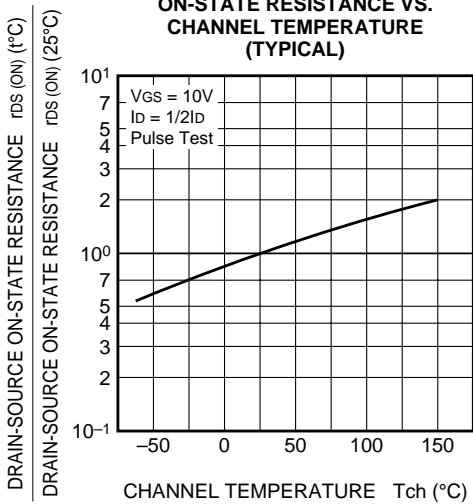
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



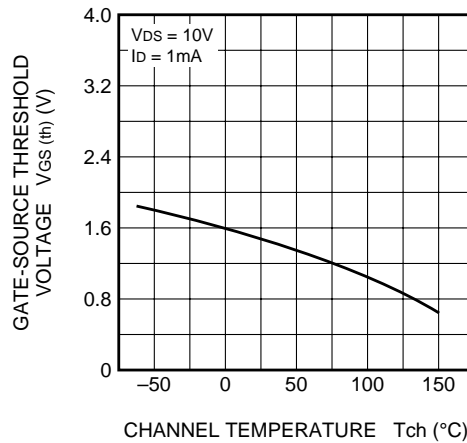
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



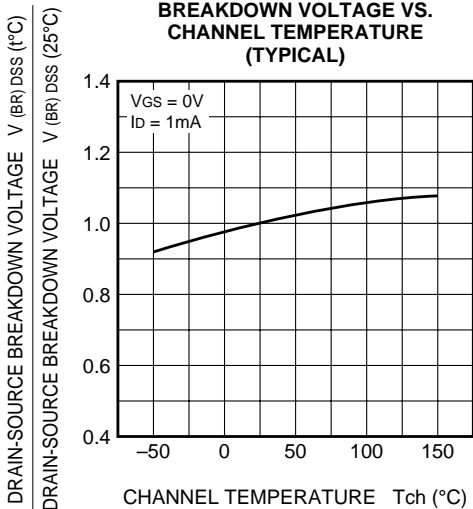
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

